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Docket No.: M4065.0338/P338-A  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Richard H. Lane

Application No.: 09/989,372

Confirmation No.: 1348

Filed: November 21, 2001

Art Unit: 2818

For: ELECTROPOLISHED PATTERNED METAL  
LAYER FOR SEMICONDUCTOR DEVICES

Examiner: C. A. Luu

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated July 13, 2006, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.